OVB/F 10x634,274

Filed:

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application: Paul A. Farrar Serial No.: 10/634,274

10/634,274 Group Art Unit:

August 05, 2003 Docket:

Title: H2 Plasma Treatment

Examiner: Brook Kebede

tet: 1303.110US1

2823

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

MS Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

In compliance with the duty imposed by 37 C.F.R. § 1.56, and in accordance with 37 C.F.R. §§ 1.97 et. seq., the enclosed materials are brought to the attention of the Examiner for consideration in connection with the above-identified patent application. Applicant respectfully requests that this Supplemental Information Disclosure Statement be entered and the documents listed on the attached Form 1449 be considered by the Examiner and made of record. Pursuant to the provisions of MPEP 609, Applicant requests that a copy of the 1449 form, initialed as being considered by the Examiner, be returned to the Applicant with the next official communication.

Pursuant to 37 C.F.R. §1.97(b), it is believed that no fee or statement is required with the Supplemental Information Disclosure Statement. However, if an Office Action on the merits has been mailed, the Commissioner is hereby authorized to charge the required fees to Deposit Account No. 19-0743 in order to have this Supplemental Information Disclosure Statement considered.

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Serial No:10/634,274
Filing Date: August 05, 2003
Title: H2 Plasma Treatment

2 Plasma Treatment

The Examiner is invited to contact the Applicant's Representative at the below-listed telephone number if there are any questions regarding this communication.

The present application is either a U.S. national patent application filed after June 30, 2003 or an international application that entered the national stage under 35 U.S.C. § 371 after June 30, 2003. Thus, Applicant believes that the U.S. Patent & Trademark Office has waived the requirement under 37 C.F.R. 1.98 (a)(2)(i) for submitting a copy of each cited U.S. patent and each U.S. patent application publication. The waiver is provided in a pre-OG notice from the U.S. Patent & Trademark Office entitled "Information Disclosure Statements May Be Filed Without Copies of U.S. Patents and Published Applications in Patent Applications filed after June 30, 2003" and dated July 11, 2003. Applicant acknowledges the requirement to submit copies of foreign patent documents and non-patent literature in accordance with 37 C.F.R. 1.98(a)(2).

Respectfully submitted,

PAUL A. FARRAR

By his Representatives,

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(612) 371-2157

Date / Jeften 2004 By

David R. Cochfan

Reg. No. 46,632

CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: MS Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on this _____ day of September, 2004.

Name Vira Kohul

Signature

PTO/SB/08A(10-01)

Approved for use through 10/31/2002, OMB 651-0031

US Patent & Trademark Office; U.S. DEPARTMENT OF COMMERCE

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Substitute for form 1449A/PTO	Complete if Known	required to respond to a collection of information unless it contrains a valid OMS control numb
INFORMATION DISCLOSURE	Application Number	10/634,274
STATEMENT BY APPLICANT (Use as many sheets as necessary)	Filing Date	August 5, 2003
(Osc as many shocks as moodssary)	First Named Inventor	Farrar, Paul
SEP 1 0 2004		2823
	ㅋ !	Kebede, Brook
Sheet 1 of 1	Attorney Docket No: 1	1303.110US1

US PATENT DOCUMENTS								
Examiner Initial *	USP Document Number	Publication Date	Name of Patentee or Applicant of cited Document	Class	Subclass	Filing Date If Appropriate		
	US-6,208,016	03/27/2001	Farrar, Paul	257	643	02/24/1999		
	US-6,288,442	09/11/2001	Farrar, Paul A.	257	678	09/10/1998		
	US-6,358,849	03/19/2002	Havemann, R. H., et al.	438	689	12/21/1999		
	US-6,552,432	04/22/2003	Farrar, Paul A.	257	751	08/30/2001		
	US-6,614,099	09/02/2003	Farrar, Paul A.	257	643	09/04/2001		
	US-6,743,716	06/01/2004	Farrar, Paul A.	438	652	07/16/2002		
	US-6,756,298	06/29/2004	Ahn, Kie Y., et al.	438	635	08/01/2002		

S/9 10/634,274 PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:

Paul A. Farrar

Examiner: Brook Kebede

Serial No.:

10/634,274

Group Art Unit: 2823

Filed:

August 5, 2003

Docket: 1303.110US1

Title:

H2 PLASMA TREATMENT

COMMUNICATION CONCERNING RELATED APPLICATION(S)

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Applicant would like to bring to the Examiner's attention the following related application(s) in the above-identified patent application:

Serial/Patent No. 09/483869 6420262	Filing Date January 18, 2000	Attorney Docket 303.664US1	Title STRUCTURES AND METHODS TO ENHANCE COPPER METALLIZATION
09/484002 6376370	January 18, 2000	303.673US1	PROCESS FOR PROVIDING SEED LAYERS FOR USING ALUMINUM, COPPER, GOLD AND SILVER METALLURGY
10/117041	April 5, 2002	303.673US2	INTEGRATED CIRCUIT AND SEED LAYERS
10/196078 6743716	July 16, 2002	303.664US2	STRUCTURES AND METHODS TO ENHANCE COPPER METALLIZATION
10/196081	July 16, 2002	303.664US3	STRUCTURES AND METHODS TO ENHANCE COPPER METALLIZATION
10/195965	July 16, 2002	303.664US4	STRUCTURES AND METHODS TO ENHANCE COPPER METALLIZATION
09/534224 6426289 10/137293	March 24, 2000 May 3, 2002		
08/892114 6077792 09/480290	July 14, 1997 January 10, 2000		

COMMUNICATION CONCERNING RELATED APPLICATIONS

Serial Number: 10/634,274 Filing Date: August 5, 2003 Title: H2 PLASMA TREATMENT Page 2 Dkt: 1303.110US1

10/789882	February 27, 2004	303.673US3	INTEGRATED CIRCUIT AND SEED LAYERS
10/854552	May 26, 2004	303.664US5	STRUCTURES AND METHODS TO ENHANCE COPPER METALLIZATION
09/534224 6426289	March 24, 2000		
10/137293	May 3, 2002		
08/892114 6077792	July 14, 1997		
09/480290	January 10, 2000		

Respectfully submitted,

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Date 7 September 2004

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CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on this ______ day of September, 2004.

Name

Signature